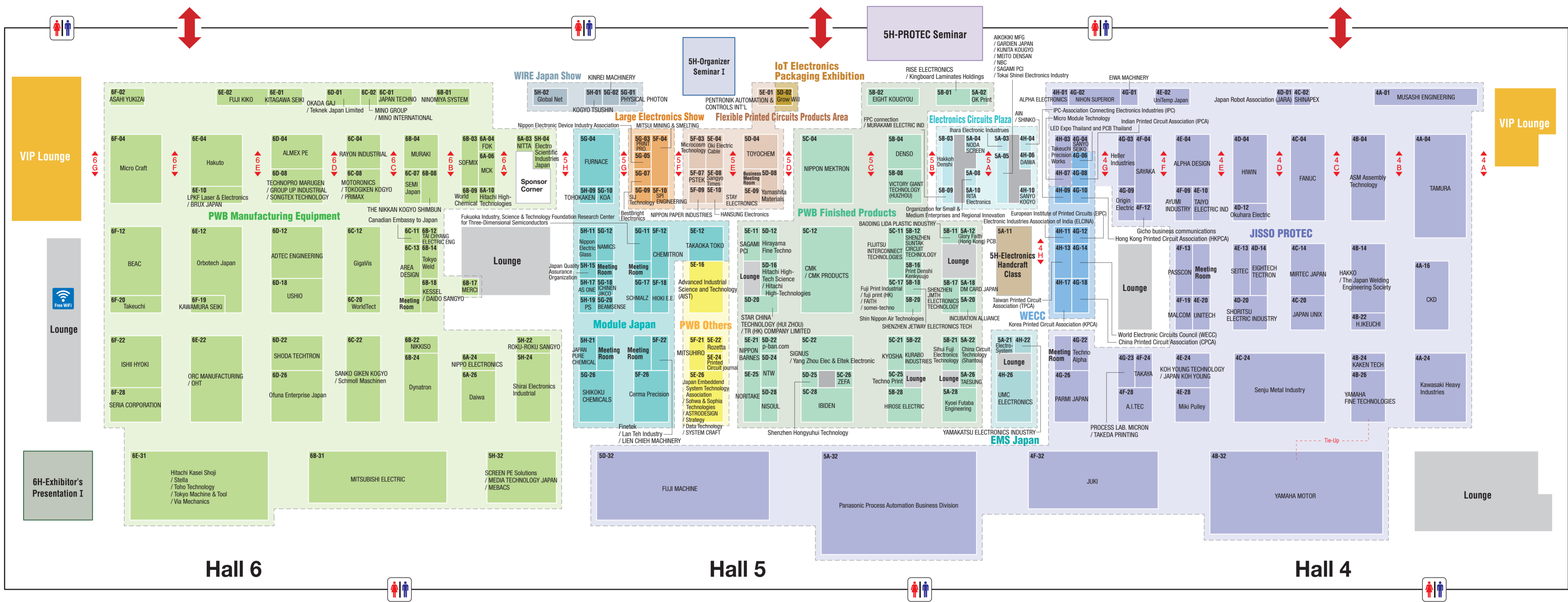


# Floor Map / List of Exhibitors

2017.6.7 (Wed.) - 9 (Fri.)  
Tokyo Big Sight, East Hall 4-8



Company Name	booth No.	Exhibition
A.I.TEC	4F-28	JISSO PROTEC
ADTEC ENGINEERING	6D-12	PWB Technology
Advanced Industrial Science and Technology (AIST)	5E-16	PWB Technology
AIKOKIKI MFG.	5A-05	PWB Technology
AIN	4H-04	PWB Technology
ALMEX PE	6D-04	PWB Technology
ALPHA DESIGN	4E-04	JISSO PROTEC
ALPHA ELECTRONICS	4H-01	JISSO PROTEC
AREA DESIGN	6C-13	PWB Technology
AS ONE	5H-17	Module Japan
ASAHI YUKIZAI	6F-02	PWB Technology
ASM Assembly Technology	4B-04	JISSO PROTEC
ASTRODESIGN	5E-26	PWB Technology
AYUMI INDUSTRY	4F-09	JISSO PROTEC
BAODING LIDA PLASTIC INDUSTRY	5B-11	PWB Technology
BEAC	6F-12	PWB Technology
BEAMSENSE	5G-20	Module Japan
BestBright Electronics	5G-07	Device Engineering
BRUX JAPAN	6E-10	PWB Technology
Canadian Embassy to Japan	6C-11	PWB Technology
Cerma Precision	5F-26	Module Japan
CHEMTRON	5F-12	Module Japan
China Circuit Technology (Shantou)	5A-22	PWB Technology
China Printed Circuit Association (CPCA)	4G-18	WECC
CKD	4A-16	JISSO PROTEC
CMK	5C-12	PWB Technology
CMK PRODUCTS	5C-12	PWB Technology
DAIDO SANGYO	6B-18	PWB Technology
DAIWA	4H-06	PWB Technology
Daiwa	6A-26	PWB Technology
Data Technology	5E-26	PWB Technology
DENSO	5B-04	PWB Technology
DM CARD JAPAN	5A-18	PWB Technology
Dynatron	6B-24	PWB Technology
EIGHT KOUGYOU	5B-02	PWB Technology
EIGHTECH TECTRON	4D-14	JISSO PROTEC
EIWA MACHINERY	4G-01	JISSO PROTEC
Electro Scientific Industries Japan	5H-04	PWB Technology
Electronic Industries Association of India (ELCINA)	4H-11	WECC
Electro-System	5A-21	EMS Japan
European Institute of Printed Circuits (EIPC)	4G-12	WECC
FAITH	5C-17	PWB Technology
FANUC	4C-04	JISSO PROTEC
FDK	6A-04	PWB Technology
Finetek	5F-22	Module Japan
FPC connection	5B-09	PWB Technology
FLUJI KIKO	6E-02	PWB Technology
FLUJI MACHINE MFG.	5D-32	JISSO PROTEC
fujii print (HK)	5C-17	PWB Technology
Fuji Print Industrial	5C-17	PWB Technology
FUJITSU INTERCONNECT TECHNOLOGIES	5C-11	PWB Technology

Company Name	booth No.	Exhibition
Fukuoka Industry, Science & Technology Foundation Research Center for Three-Dimensional Semiconductors	5G-11	Module Japan
FURNACE	5G-04	Module Japan
GARDIEN JAPAN	5A-05	PWB Technology
GigoVis	4F-12	JISSO PROTEC
GigaVis	6C-12	PWB Technology
Global Net	5H-02	WIRE Japan Show
Glory Faith (Hong Kong) PCB	5A-12	PWB Technology
GROUP UP INDUSTRIAL	6D-08	PWB Technology
Grow Will	5D-02	IoT Electronics Packaging Exhibition
H.I.KEUCHI	4B-22	JISSO PROTEC
HAKKO	4B-14	JISSO PROTEC
Hakko Denshi	5B-03	PWB Technology
HAKU	6E-04	PWB Technology
HANSUNG Electronics	5E-10	Flexible Printed Circuits Products Area
Heller Industries	4G-03	JISSO PROTEC
HIOKI E.E.	5F-18	Module Japan
Hirayama Fine Techno	5D-12	PWB Technology
HIROSE ELECTRIC	5B-28	PWB Technology
Hitachi High-Tech Science	5D-16	PWB Technology
Hitachi High-Technologies	5D-16	PWB Technology
Hitachi High-Technologies	6A-10	PWB Technology
Hitachi Kasei Shoji	6E-31	PWB Technology
HIWIN	4D-04	JISSO PROTEC
Hong Kong Printed Circuit Association (HKPCA)	4G-10	WECC
IBIDEN	5C-28	PWB Technology
ICHINEN JIKCO	5G-18	Module Japan
Ihara Electronic Industries	5A-03	PWB Technology
INCUBATION ALLIANCE	5A-20	PWB Technology
Indian Printed Circuit Association (IPCA)	4G-08	WECC
IPC-Association Connecting Electronics Industries (IPC)	4H-09	WECC
ISHII HYOKI	6F-22	PWB Technology
Japan Embeddend System Technology Association	5E-26	PWB Technology
JAPAN KOH YOUNG	4E-24	JISSO PROTEC
JAPAN PURE CHEMICAL	5H-21	Module Japan
JAPAN QUALITY ASSURANCE ORGANIZATION	5H-15	PWB Technology
Japan Robot Association (JARA)	4D-01	JISSO PROTEC
JAPAN TECHNO	6C-01	PWB Technology
JAPAN UNIX	4C-20	JISSO PROTEC
JUKI	4F-32	JISSO PROTEC
KAKEN TECH	4B-24	JISSO PROTEC
KAWAMURA SEIKI	6F-19	PWB Technology
Kawasaki Heavy Industries	4A-24	JISSO PROTEC
KESSEL	6B-18	PWB Technology
Kingboard Laminates Holdings	5B-01	PWB Technology
KINREI MACHINERY	5G-02	WIRE Japan Show
KITAGAWA SEIKI	6E-01	PWB Technology
KOA	5G-10	Module Japan
KOGYO TSUSHIN	5H-01	WIRE Japan Show
KOH YOUNG TECHNOLOGY	4E-24	JISSO PROTEC
Korea Printed Circuit Association (KPCA)	4H-17	WECC

Company Name	booth No.	Exhibition
KUNITA KOUGYO	5A-05	PWB Technology
KURABO INDUSTRIES	5B-22	PWB Technology
Kyoei Futaba Engineering	5A-28	PWB Technology
KYOSHA	5C-21	PWB Technology
Lan Teh Industry	5F-22	Module Japan
LED Expo Thailand and PCB Thailand	4G-06	WECC
LIEN CHIEH MACHINERY	5F-22	Module Japan
LPKF Laser & Electronics	6E-10	PWB Technology
MALCOM	4F-19	JISSO PROTEC
MCK	6A-06	PWB Technology
MEBACS	5H-32	PWB Technology
MEDIA TECHNOLOGY JAPAN	5H-32	PWB Technology
MEITO DENSAN	5A-05	PWB Technology
MERCI	6B-17	PWB Technology
Micro Craft	6F-04	PWB Technology
Micro Module Technology	4H-07	JISSO PROTEC
Microcosm Technology	5F-03	Flexible Printed Circuits Products Area
Miki Pulley	4E-28	JISSO PROTEC
MINO GROUP	6C-02	PWB Technology
MINO INTERNATIONAL	6C-02	PWB Technology
MIRTEC JAPAN	4C-14	JISSO PROTEC
MITSUBISHI ELECTRIC	6B-31	PWB Technology
MITSUHIRO	5F-21	PWB Technology
MITSUI MINING & SMELTING	5F-04	PE PROCESS
MOTORONICS	6C-08	PWB Technology
MURAKAMI ELECTRIC IND.	5B-09	PWB Technology
MURAKI	6B-04	PWB Technology
MUSASHI ENGINEERING	4A-01	JISSO PROTEC
NAMICS	5G-12	Module Japan
NBC	5A-05	PWB Technology
NIHON SUPERIOR	4G-02	JISSO PROTEC
NIKKISO	6B-22	PWB Technology
NINOMIYA SYSTEM	6B-01	PWB Technology
NIPPO ELECTRONICS	6A-24	PWB Technology
NIPPON BARNES	5E-21	Module Japan
Nippon Electric Glass	5H-11	Module Japan
Nippon Electronic Device Industry Association	5G-05	Large Electronics Show
NIPPON MEKTRON	5C-04	PWB Technology
NIPPON PAPER INDUSTRIES	5F-09	Flexible Printed Circuits Products Area
NISOU	5D-28	PWB Technology
NITTA	6A-03	PWB Technology
NODA SCREEN	5A-04	PWB Technology
NORITAKE	5E-25	PWB Technology
NTW	5D-24	PWB Technology
Ofuna Enterprise Japan	5B-01	PWB Technology
OHT	6E-22	PWB Technology
OK Print	5A-02	PWB Technology
OKADA GAJ	6D-01	PWB Technology
Ok Electric Cable	5E-04	Flexible Printed Circuits Products Area
Okuhara Electric	4D-12	JISSO PROTEC
Orbotech Japan	6E-12	PWB Technology

Company Name	booth No.	Exhibition
ORC MANUFACTURING	6E-22	PWB Technology
Organization for Small & Medium Enterprises and Regional Innovation	5A-08	PWB Technology
Origin Electric	4G-09	JISSO PROTEC
Panasonic Process Automation Business Division	5A-32	JISSO PROTEC
PARMI JAPAN	4G-26	JISSO PROTEC
PASSCON	4F-13	JISSO PROTEC
p-ban.com	5D-22	PWB Technology
PENTRONIK AUTOMATION & CONTROLS INT'L	5E-01	Flexible Printed Circuits Products Area
PHYSICAL PHOTON	5G-01	WIRE Japan Show
PRIMAX	6C-08	PWB Technology
Print Denshi Kenkyuujyo	5B-16	PWB Technology
PRINT PRO	5G-03	PE PROCESS
Printed Circuit Journal	5E-24	PWB Technology
PROCESS LAB. MICRON	4G-23	JISSO PROTEC
PS	5H-19	Module Japan
PSTEK	5F-07	Flexible Printed Circuits Products Area
RAYON INDUSTRIAL	6C-04	PWB Technology
RISE ELECTRONICS	5B-01	PWB Technology
RITA Electronics	5A-10	PWB Technology
ROKU-ROKU SANGYO	5H-22	PWB Technology
Rozetta	5E-22	PWB Technology
SAGAMI PCI	5E-11	PWB Technology
SAGAMI PCI	5A-05	PWB Technology
Sanyo Times	5E-08	Flexible Printed Circuits Products Area
SANKO GIKEN KOGYO	6C-22	PWB Technology
SANYO KOGYO	4H-10	PWB Technology
SANYOSEIKO	4G-04	JISSO PROTEC
SAYAKA	4F-04	JISSO PROTEC
SCHMALZ	5G-17	PWB Technology
Schmolli Maschinen	6C-22	PWB Technology
SCREEN PE Solutions	5H-32	PWB Technology
SEITEC	4E-13	JISSO PROTEC
SEMI Japan	6C-07	PWB Technology
Senju Metal Industry	4C-24	JISSO PROTEC
SERIA	6F-28	PWB Technology
Shenzhen Hongyuhui Technology	5D-25	PWB Technology
SHENZHEN JETWAY ELECTRONICS TECH	5B-18	PWB Technology
SHENZHEN JMTH ELECTRONICS TECHNOLOGY	5B-17	PWB Technology
SHENZHEN SUNTAK CIRCUIT TECHNOLOGY	5B-12	PWB Technology
SHIKOKU CHEMICALS	5G-26	Module Japan
Shin Nippon Air Technologies	5B-20	PWB Technology
SHINAPEX	4C-02	JISSO PROTEC
SHINKO	4H-04	PWB Technology
Shiral Electronics Industrial	5H-24	PWB Technology
SHODA TECTRON	6D-22	PWB Technology
SHORITSU ELECTRIC INDUSTRY	4D-20	JISSO PROTEC
SIGNUS	5C-22	PWB Technology
Sihui Fuji Electronics Technology	5B-21	PWB Technology
SIJ Technology	5G-09	PE PROCESS
SOFMIX	6B-03	PWB Technology
Sohwa & Sophia Technologies	5E-26	PWB Technology

Company Name	booth No.	Exhibition
somei-techno	5C-17	PWB Technology
SONGTEX TECHNOLOGY	6D-08	PWB Technology
SPI ENGINEERING	5F-10	Device Engineering
Star China Technology (Hong Kong)	5D-20	PWB Technology
STAY ELECTRONICS	5E-09	Flexible Printed Circuits Products Area
Stella	6E-31	PWB Technology
Strategy	5E-26	PWB Technology
SYSTEM CRAFT	5E-26	PWB Technology
TAESUNG	5A-26	PWB Technology
TAI CHYANG ELECTRIC ENG	6B-12	PWB Technology
Taiwan Printed Circuit Association (TPCA)	4H-13	WECC
TAIYO ELECTRIC IND.	4E-10	JISSO PROTEC
TAKAOKA TOKO	5E-12	Module Japan
TAKAYA	4F-24	JISSO PROTEC
TAKEDA PRINTING	4G-23	JISSO PROTEC
Takeuchi	6F-20	PWB Technology
Takeuchi Precision Works	4H-03	JISSO PROTEC
TAMURA	4A-04	JISSO PROTEC
Techno Alpha	4G-22	JISSO PROTEC
Techno Print	5C-25	PWB Technology
TECHNOPRO MARUGEN	6D-08	PWB Technology
Teknek Japan Limited	6D-01	PWB Technology
The Japan Welding Engineering Society	4B-14	JISSO PROTEC
THE NIKKAN KOGYO SHIMBUN	6B-08	PWB Technology
Toho Technology	6E-31	PWB Technology
TOHOKAKEN	5H-09	Module Japan
Tokai Shinei Electronics Industry	5A-05	PWB Technology
TOKOGIKEN KOGYO	6C-08	PWB Technology
Tokyo Machine & Tool	6E-31	PWB Technology
Tokyo Weld	6B-14	PWB Technology
TOYOICHEM	5D-04	Flexible Printed Circuits Products Area
TR (HK)	5D-20	PWB Technology
UMC ELECTRONICS	4H-26	EMS Japan
UNITECH	4E-20	JISSO PROTEC
UniTemp Japan	4E-02	JISSO PROTEC
USHIO	6D-18	PWB Technology
Via Mechanics	6E-31	PWB Technology
VICTORY GIANT TECHNOLOGY (HUIZHOU)	5B-08	PWB Technology
World Chemical	6B-09	PWB Technology
World Electronic Circuits Council (WECC)	4G-14	WECC
WorldTect	6C-20	PWB Technology
YAMAHA FINE TECHNOLOGIES	4B-26	JISSO PROTEC
YAMAHA MOTOR	4B-32	JISSO PROTEC
YAMAKATSU ELECTRONICS INDUSTRY	4H-22	EMS Japan
Yamashita Materials	5D-08	Flexible Printed Circuits Products Area
Yang Zhou Elec & Eltek Electronic	5C-22	PWB Technology
ZEFA	5C-26	PWB Technology

# Floor Map / List of Exhibitors

2017.6.7 (Wed.) - 9 (Fri.)  
Tokyo Big Sight, East Hall 4-8



Link to X  
**Meltex**  
7B-20

木陽インキ製造株式会社  
**TAIYO INK MFG. CO., LTD.**  
7A-47-08  
7B-04  
7G-47

**MekTEC**  
日本メクトロン株式会社  
5C-04

**orbotech**  
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6E-12

**SHIKOKU**  
GlicAP™  
Chemical Adhesion Process  
5G-26

**FPCコネクト**  
FPC connection co.,ltd.  
5B-09

**fischer**  
7D-22

**esi**  
Designed for Brilliance. Engineered for Production.  
5H-04

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Next Show **2018.6.6 (Wed.) - 8 (Fri.)**  
Tokyo Big Sight, East Hall

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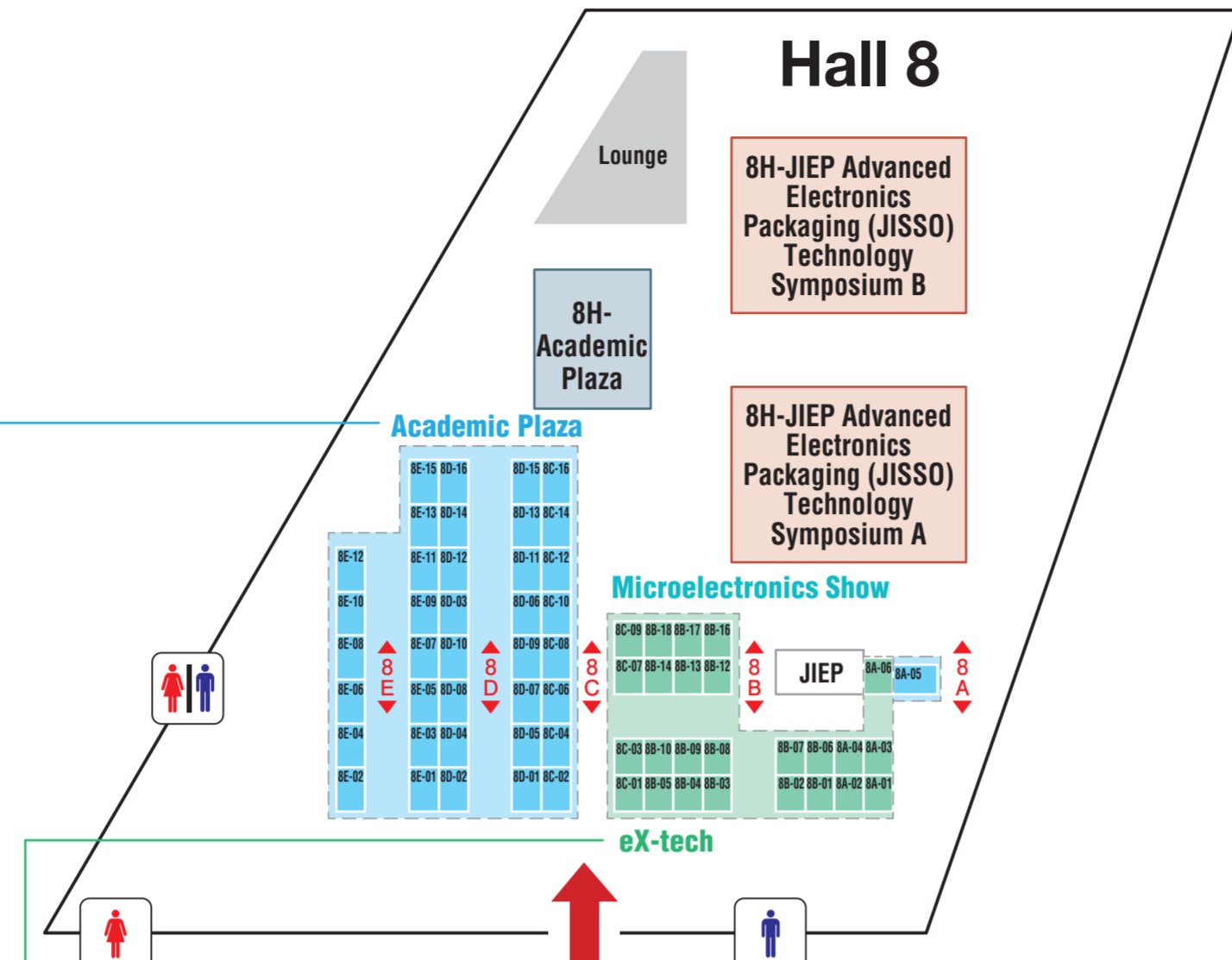
- JPCA Show 2018
- 2018 Microelectronics Show
- JISSO PROTEC 2018
- Large Electronics Show 2018
- WIRE Japan Show 2018

## Academic Plaza

8A-05	The Foundation for Technology Promotion of Electronic Circuit Board
8C-02	The Japan Institute of Electronics Packaging, Mission Fellow
8C-04	Shirashi Laboratory, Mechanical Science and Technology, Graduate School, Gunma University / Realize Computer Engineering
8C-06	Graduate School of Science and Technology, Gunma University
8C-08	National Institute of Technology, Gunma College, Department of Mechanical Engineering, Laboratory of Material Design
8C-10	Kyoto Municipal Institute of Industrial Technology and Culture
8C-12	Kyoto Municipal Institute of Industrial Technology and Culture
8C-14	Kyoto Municipal Institute of Industrial Technology and Culture
8C-16	Kyoto Municipal Institute of Industrial Technology and Culture
8D-01	Koiva Lab., College of Science and Engineering, Kanto Gakuin University
8D-02	Ok Engineering / Kanto Gakuin University
8D-03	Higurashi Lab. The University of Tokyo
8D-04	Koiva Lab., Dept. of Applied Chemistry, College of Science and Engineering, Kanto Gakuin University / Photo Technica
8D-05	Faculty of Science and Engineering, Waseda University
8D-06	Koiva Lab., Dept. of Applied Materials and Life Science, Graduate School of Engineering, Kanto Gakuin University / Research Organization for Nano & Life Innovation, Waseda University
8D-06	Kobe University Graduate School of Science Kimura Research Group
8D-07	Advanced Magnetic Devices Lab. and Nakayama Lab., Spin Device Technology Center
8D-08	Nakayama Lab. And Advanced Magnetic Devices Lab., Spin Device Technology Center
8D-09	Advanced Magnetic Devices Lab., Dept. of Electrical and Computer Eng., Fac. of Eng., Shinshu Univ.
8D-10	Nakayama Lab., National Institute of Technology, Nagano College
8D-11	Laboratory for Additive Manufacturing Science, Institute of Industrial Science, The University of Tokyo
8D-12	EXTCOM / Kyushu University, Graduate School of Life Sciences, Nano Micro Medical Laboratory / The University of Tokyo, Higurashi Lab
8D-13	The University of Tokyo
8D-14	Graduate School of Information Science and Electrical Engineering, Kyushu University
8D-15	Materials Process Laboratory, Department of Chemical Engineering, Graduate School of Engineering, Osaka Prefecture University
8D-16	Molecular Recognition Research Group, Graduate School of Engineering, Osaka Prefecture University / GreenChem
8E-01	Osaka Research Institute of Industrial Science and Technology
8E-02	Tohoku University, FRIS, Shimadzu Laboratory
8E-03	Tokyo Metropolitan Industrial Technology Research Institute
8E-04	Reaction and Reactor Engineering Lab., Department of Chemical and Energy Engineering, Yokohama National University
8E-05	Tokyo University of Science, Yamaguchi
8E-06	Micro Design Lab., Department of Precision Machinery Engineering, College of Science and Technology, Nihon University
8E-07	Waseda University Information, Production and Systems Research Center, Tatsumi Laboratory
8E-08	Koshiji Laboratory, Department of Electronics and Mechatronics, Faculty of Engineering, Tokyo Polytechnic University
8E-09	Dept. Advanced Interconnect Materials, The Institute of Scientific and Industrial Research, Osaka University
8E-10	Department of Mechanical Engineering, Graduate School of Science and Engineering, Kagoshima University / Research Committee RC271, Japan Society of Mechanical Engineering
8E-11	Manufacturing System Design Laboratory, Faculty of Science and Engineering, Doshisha University / Ogawa Laboratory, Department of Mechanical and Systems Engineering, Faculty of Science and Technology Ryukoku University
8E-12	Collaborative Research Center, Meisei University
8E-13	Meiji University, School of Science and Technology, Department of Mechanical Engineering, Laboratory of Measurement Science and Information
8E-15	Shibaura Institute Technology Energy material Lab

## eX-tech

8A-01	TOTAS
8A-02	Kobe University Graduate School of Science Kimura Research Group / Integral Geometry Science
8A-03	ViewChin Imaging
8A-04	AKITA CHEMICAL INDUSTRIES
8A-06	Gokuh
8B-01	TOUHOKU ONE PEACE
8B-02	Sulfur Chemical Laboratory
8B-03	ATHENE
8B-04	Shimada Appli
8B-05	WELL Plasma System Sales Div.
8B-06	Merck Performance Materials
8B-07	Enplas Semiconductor Peripheral
8B-08	Namiki Precision Jewel
8B-09	Hitachi Power Solutions
8B-10	OKAMOTO MACHINE TOOL WORKS
8B-12	NIPPON SHEET GRASS
8B-13	DIC
8B-14	ESPEC
8B-16	ORUTE CORPORATION
8B-17	ePRONICS
8B-18	ALPHA DESIGN
8C-01	WELL Test Wafer Div.
8C-03	Fujitsu Quality Laboratory
8C-07	FUJIKURA KASEI
8C-09	APIC YAMADA



Company Name	Booth No.	Exhibition
Accelad	7G-29	PWB Technology
ADT	7G-30	PWB Technology
Advanced Magnetic Devices Lab. and Nakayama Lab., Spin Device Technology Center	8D-07	Academic Plaza
Advanced Magnetic Devices Lab., Dept. of Electrical and Computer Eng., Fac. of Eng., Shinshu Univ.	8D-09	Academic Plaza
AGFA Materials Japan	7A-37	PWB Technology
AgIC	7G-47	JPCA Challenge 2017
AKITA CHEMICAL INDUSTRIES	8A-04	eX-tech
ALPHA DESIGN	8B-18	eX-tech
APIC YAMADA	8C-09	eX-tech
ASKA ENGINEERING	7B-12	PWB Technology
atg Luther & Maelzer	7F-14	PWB Technology
ATHENE	8B-03	eX-tech
Atotech Japan	7A-04	PWB Technology
AURORA INDUSTRIES	7G-34	PWB Technology
BSEF Japan	7A-35	PWB Technology
C.Uyemura	7B-14	PWB Technology
Chiba Prefectural Government	7A-43	PWB Technology
C-INK	7A-39	PWB Technology
Collaborative Research Center, Meisei University	8E-12	Academic Plaza
CSI Global Alliance	7F-30	PWB Technology
DAIEI ELECTRONICS	7A-47-04	3D-MID
DEMPA PUBLICATIONS	7G-16	PWB Technology
Department of Mechanical Engineering, Graduate School of Science and Engineering, Kagoshima University	8E-10	Academic Plaza
Dept. Advanced Interconnect Materials, The Institute of Scientific and Industrial Research, Osaka University	8E-09	Academic Plaza
DIU	8B-13	eX-tech
DU PONT-TORAY	7D-38	PWB Technology
Ebina Denka Kogyo	7A-47-02	3D-MID
Electroplating Engineers of Japan	7B-37	PWB Technology
Enplas Semiconductor Peripheral	8B-07	eX-tech
ePRONICS	8B-17	eX-tech
ESPEC	8B-14	eX-tech
Eternal Materials	7C-10	PWB Technology
EVERETT CHARLES JAPAN	7F-14	PWB Technology
EXTCOM	8D-12	Academic Plaza
Faculty of Science and Engineering, Waseda University	8D-05	Academic Plaza
FISCHER INSTRUMENTS	7D-22	PWB Technology
FlashAir Developers	7G-47	JPCA Challenge 2017
FUJII MACHINE	7A-47-07	3D-MID
FUJIFILM Global Graphic Systems	7C-20	PWB Technology
FUJIKURA KASEI	8C-07	eX-tech
FUJITSU INTERCONNECT TECHNOLOGIES	7G-47	JPCA Challenge 2017
Fujitsu Quality Laboratory	8C-03	eX-tech
FUKUDA METAL FOIL & POWDER	7H-37	PWB Technology
Fukushima PR booth	7H-38	PWB Technology
Goal Searchers, ZHUHAI	7A-12	PWB Technology
Gokuh	8A-06	eX-tech
GOO CHEMICAL	7G-47	JPCA Challenge 2017
GOO CHEMICAL	7A-09	PWB Technology
Graduate School of Information Science and Electrical Engineering, Kyushu University	8D-14	Academic Plaza
Graduate School of Science and Technology, Gunma University	8C-06	Academic Plaza
GreenChem	8D-16	Academic Plaza
Hamamatsu Kiban Kogyo	7G-47	JPCA Challenge 2017
Hitachi Chemical	7C-26	PWB Technology
Hitachi Casei Shoji	7C-26	PWB Technology
Hitachi Power Solutions	8B-09	eX-tech
HWAIN TRADING	7C-38	PWB Technology
INCOM	7D-19	PWB Technology
Inspep	7D-14	PWB Technology
Integral Geometry Science	8A-02	eX-tech
ISHIHARA CHEMICAL	7A-25	PWB Technology
Iwate Industrial Research Institute	7A-47-12	3D-MID
JABURO INDUSTRY	7A-13	PWB Technology
JADASON Enterprises	7C-38	PWB Technology
Japan Electronics Packaging and Circuits Association (JPCA)	7G-47	JPCA Challenge 2017
Japan Institute of Electronics Packaging	8H	Microelectronics Show
Japan MID Association	7A-47-15	3D-MID
JCU	7C-04	PWB Technology
JPCA BookStore	7G-43	PWB Technology
J-RAS	7F-24	PWB Technology
JT	7F-44	PWB Technology
JX Nippon Mining & Metals	7D-44	PWB Technology
KAMITSU	7D-14	PWB Technology
Kanagawa Institute of Industrial Science and Technology	7A-42	PWB Technology
KANEKA	7E-44	PWB Technology
Kanto Gakuin University	8D-02	Academic Plaza
Kobe University Graduate School of Science Kimura Research Group	8A-02	eX-tech
Kobe University Graduate School of Science Kimura Research Group	8D-06	Academic Plaza
Koiva Lab., College of Science and Engineering, Kanto Gakuin University	8D-01	Academic Plaza
Koiva Lab., Dept. of Applied Chemistry, College of Science and Engineering, Kanto Gakuin University	8D-04	Academic Plaza
Koiva Lab., Dept. of Applied Material and Life Science, Graduate School of Engineering, Kanto Gakuin University	8D-05	Academic Plaza
Koshiji Laboratory, Department of Electronics and Mechatronics, Faculty of Engineering, Tokyo Polytechnic University	8E-08	Academic Plaza
KPD	7G-47	JPCA Challenge 2017
Kumamoto PR booth	7H-40	PWB Technology
KYOEI PRINT GIKEN	7A-22	PWB Technology
Kyoto Municipal Institute of Industrial Technology and Culture	8C-10	Academic Plaza
Kyoto Municipal Institute of Industrial Technology and Culture	8C-12	Academic Plaza
Kyoto Municipal Institute of Industrial Technology and Culture	8C-14	Academic Plaza
Kyoto Municipal Institute of Industrial Technology and Culture	8C-16	Academic Plaza
Kyushu University, Graduate School of Life Sciences, Nano Micro Medical Laboratory	8D-12	Academic Plaza
Laboratory for Additive Manufacturing Science, Institute of Industrial Science, The University of Tokyo	8D-11	Academic Plaza
Lingbao Hongyu Electronics	7F-31	PWB Technology
LPKF Laser & Electronics	7A-47-06	3D-MID
MacDermid Enthone	7A-01	PWB Technology
MacDermid Enthone	7A-47-14	3D-MID
Manufacturing System Design Laboratory, Faculty of Science and Engineering, Doshisha University	8E-11	Academic Plaza
Materials Process Laboratory, Department of Chemical Engineering, Graduate School of Engineering, Osaka Prefecture University	8D-15	Academic Plaza
MATSUDA SANGYO	7A-44	PWB Technology
MATSUO SANGYO	7G-23	PWB Technology
Matsusada Precision	7E-14	PWB Technology
MEC	7C-22	PWB Technology
Meiji University, School of Science and Technology, Department of Mechanical Engineering, Laboratory of Measurement Science and Information	8E-13	Academic Plaza
Meltex	7B-20	PWB Technology
Merck Performance Materials	8B-06	eX-tech
Micro Design Lab., Department of Precision Machinery Engineering, College of Science and Technology, Nihon University	8E-06	Academic Plaza
MITSUBISHI GAS CHEMICAL	7E-26	PWB Technology

Company Name	Booth No.	Exhibition
Molecular Recognition Research Group, Graduate School of Engineering, Osaka Prefecture University	8D-16	Academic Plaza
Molex Japan LLC	7A-47-01	3D-MID
Murata Manufacturing	7F-17	PWB Technology
Nagano Prefectural Government	7A-45	PWB Technology
NAKAJIMA KAGAKUSANGYO	7G-34	PWB Technology
Nakayama Lab. And Advanced Magnetic Devices Lab., Spin Device Technology Center	8D-08	Academic Plaza
Nakayama Lab., National Institute of Technology, Nagano College	8D-10	Academic Plaza
Namiki Precision Jewel	8B-08	eX-tech
National Institute of Technology, Gunma College, Department of Mechanical Engineering, Laboratory of Material Design	8C-08	Academic Plaza
NIDECE-READ	7C-14	PWB Technology
NIHON KAGAKU SANGYO	7B-21	PWB Technology
NIHON PARKERIZING	7F-34	PWB Technology
NIKKAN INDUSTRIES	7H-33	PWB Technology
Nikko-Materials	7C-10	PWB Technology
NIPPON MEKTRON	7G-47	JPCA Challenge 2017
Nippon Polytech	7G-37	PWB Technology
NIPPON SHEET GRASS	8B-12	eX-tech
Ogawa Laboratory, Department of Mechanical and Systems Engineering, Faculty of Science and Technology Ryukoku University	8E-11	Academic Plaza
OKADA GAJ	7C-38	PWB Technology
OKAMOTO MACHINE TOOL WORKS	8B-10	eX-tech
Ok Electric Cable	7C-11	JPCA Challenge 2017
Ok Engineering	8D-02	Academic Plaza
Okitsumo	7B-44	PWB Technology
OKUNO CHEMICAL INDUSTRIES	7A-47-13	3D-MID
OKUNO CHEMICAL INDUSTRIES	7B-26	PWB Technology
ORUTE CORPORATION	8B-16	eX-tech
Osaka Research Institute of Industrial Science and Technology	8E-01	Academic Plaza
p-ban.com	7G-47	JPCA Challenge 2017
Panasonic	7A-47-09	3D-MID
Panasonic	7C-34	PWB Technology
PAN-TEC	7C-38	PWB Technology
Photo Technica	8D-04	Academic Plaza
Quadcept	7G-30	PWB Technology
Reaction and Reactor Engineering Lab., Department of Chemical and Energy Engineering, Yokohama National University	8E-04	Academic Plaza
Realize Computer Engineering	8C-04	Academic Plaza
Research Committee RC271, Japan Society of Mechanical Engineering	8E-10	Academic Plaza
Research Organization for Nano & Life Innovation, Waseda University	8D-05	Academic Plaza
RISHO KOGYO	7F-38	PWB Technology
ROHM AND HAAS ELECTRONIC MATERIALS (A DOW Chemical Group Company)	7A-47-05	3D-MID
ROHM AND HAAS ELECTRONIC MATERIALS (A DOW Chemical Group Company)	7A-14	PWB Technology
SAKURA COLOR PRODUCTS	7F-22	PWB Technology
SAN-EI KAGAKU	7A-19	PWB Technology
SANKO GIKEN KOGYO	7C-38	PWB Technology
Sankyokasei	7A-47-11	3D-MID
SANWA CHEMICAL INDUSTRIAL	7A-34	PWB Technology
SHANGHAI NANYA COPPER CLAD LAMINATE	7E-38	PWB Technology
SHENGYI TECHNOLOGY	7D-26	PWB Technology
SHENZHEN JINZHOU PRECISION TECHNOLOGY	7D-10	PWB Technology
ShenZhen TengXin Precision Sticks Products	7E-34	PWB Technology
Shenzhen Zens electronic	7G-21	PWB Technology
Shibaura Institute Technology Energy material Lab	8E-15	Academic Plaza
SHIIMA ELECTRONICS	7E-23	PWB Technology
Shimada Appli	8B-04	eX-tech
Shirashi Laboratory, Mechanical Science and Technology, Graduate School, Gunma University	8C-04	Academic Plaza
Smart e-plating RIS, Sungkyunkwan University	7F-44	PWB Technology
Sojitz Pla-Net	7D-26	PWB Technology
SOMAR	7B-34	PWB Technology
Stella Corporation	7F-26	PWB Technology
Sulfur Chemical Laboratory	8B-02	eX-tech
TAIWAN KONG KING	7D-14	PWB Technology
TAIYO INDUSTRIAL	7G-13	PWB Technology
TAIYO INK MFG	7A-47-08	3D-MID
TAIYO INK MFG	7G-47	JPCA Challenge 2017
TAIYO INK MFG	7B-04	PWB Technology
TAKADA	7G-18	PWB Technology
TAMURA	7D-32	PWB Technology
TATSUTA Electric Wire & Cable	7D-04	PWB Technology
TCT (JAPAN)	7B-29	PWB Technology
Techno Alpha	7A-47-03	3D-MID
The Chemical Daily	7E-21	PWB Technology
The Foundation for Technology Promotion of Electronic Circuit Board	8A-05	Academic Plaza
The Japan Institute of Electronics Packaging, Mission Fellow	8C-02	Academic Plaza
THE NIHONKOGYO SHIMBUN	7G-42	PWB Technology
The University of Tokyo	8D-13	Academic Plaza
The University of Tokyo, Higurashi Lab	8D-03	Academic Plaza
The University of Tokyo, Higurashi Lab	8D-12	Academic Plaza
Tohoku University, FRIS, Shimadzu Laboratory	8E-02	Academic Plaza
TOKYO KAKOKI	7B-20	PWB Technology
Tokyo Machine & Tool	7C-38	PWB Technology
Tokyo Metropolitan Industrial Technology Research Institute	8E-03	Academic Plaza
TOKYO OHKA KOGYO	7H-41	PWB Technology
TOKYO UNIVERSITY OF SCIENCE, YAMAGUCHI	8E-05	Academic Plaza
TOPOINT TECHNOLOGY	7B-38	PWB Technology
Toshiba IT & Control Systems	7G-22	PWB Technology
TOTAS	8A-01	eX-tech
TOUHOKU ONE PEACE	8B-01	eX-tech
TSUNODA BRUSH	7A-26	PWB Technology
Tulip	7E-18	PWB Technology
UNION TOOL	7C-38	PWB Technology
UNITIKA	7G-44	PWB Technology
Unno Giken	7G-47	JPCA Challenge 2017
Utechzone	7E-22	PWB Technology
ViewOnre Imaging	8A-03	eX-tech
Waseda University Information, Production and Systems Research Center, Tatsumi Laboratory	8E-07	Academic Plaza
WELL Plasma System Sales Div.	8B-05	eX-tech
WELL Test Wafer Div.	8C-01	eX-tech
YASUNAGA	7F-21	PWB Technology
YINGTAN JIANGNAN COPPER INDUSTRY	7G-38	PWB Technology
YONEZAWA DIA ELECTRONICS	7E-26	PWB Technology
Zen	7A-38	PWB Technology
ZHEJIANG HUAZHENG NEW MATERIAL	7G-33	PWB Technology
ZUKEN	7A-47-10	3D-MID